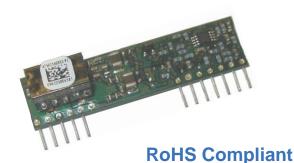
4.5Vdc –5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc –14Vdc input; 0.8Vdc to 5.5Vdc output; 25A Output Current



Applications

- Distributed power architectures
- Intermediate bus voltage applications
- Telecommunications equipment
- Servers and storage applications
- Networking equipment

Features

- Compliant to RoHS EU Directive 2011/65/EU (-Z versions)
- Compliant to RoHS EU Directive 2011/65/EU under exemption 7b (Lead solder exemption). Exemption 7b will expire after June 1, 2016 at which time this product will no longer be RoHS compliant (non-Z versions)
- Delivers up to 30A of output current
- High efficiency 93% 3.3V full load (V_{IN}=12Vdc)
- Available in two input voltage ranges

ATH: 4.5 to 5.5Vdc ATS: 6.0 to 14Vdc

Output voltage programmable from

ATH: 0.8 to 3.63Vdc

ATS: 0.8 to 5.5Vdc

Small size and low profile:

50.8 mm x 12.7 mm x 14.0 mm

2.00 in. x 0.50 in. x 0.55 in.

- Monotonic start-up into pre-biased output
- Output voltage sequencing (EZ-SEQUENCE ™)
- Remote On/Off
- Remote Sense
- Over current and Over temperature protection
- Parallel operation with active current sharing
- Wide operating temperature range (-40°C to 85°C)
- UL* 60950 Recognized, CSA† C22.2 No. 60950-00 Certified, and VDE† 0805 (EN60950-1 3rd edition) Licensed
- ISO** 9001 and ISO 14001 certified manufacturing facilities

Description

The Austin MegaLynx series SIP power modules are non-isolated DC-DC converters in an industry standard package that can deliver up to 30A of output current with a full load efficiency of 92% at 3.3Vdc output voltage ($V_{IN} = 12Vdc$). The ATH series of modules operate off an input voltage from 4.5 to 5.5Vdc and provide an output voltage that is programmable from 0.8 to 3.63Vdc, while the ATS series of modules have an input voltage range from 6 to 14V and provide a programmable output voltage ranging from 0.8 to 5.5Vdc. Both series have a sequencing feature that enables designers to implement various types of output voltage sequencing when powering multiple modules on the board. Additional features include remote On/Off, adjustable output voltage, remote sense, over current, over temperature protection and active current sharing between modules.

- * UL is a registered trademark of Underwriters Laboratories, Inc.
- † CSA is a registered trademark of Canadian Standards Association.
- VDE is a trademark of Verband Deutscher Elektrotechniker e.V.
- ** ISO is a registered trademark of the International Organization of Standards



4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

| Parameter | Device | Symbol | Min | Max | Unit |
|--------------------------------------|--------|-----------------|------|-----|------|
| Input Voltage | | | | | |
| Continuous | All | V _{IN} | -0.3 | 15 | Vdc |
| Sequencing pin voltage | All | VSEQ | -0.3 | 15 | Vdc |
| Operating Ambient Temperature | All | T _A | -40 | 85 | °C |
| (see Thermal Considerations section) | | | | | |
| Storage Temperature | All | T_{stg} | -55 | 125 | °C |

Electrical Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

| Parameter | Device | Symbol | Min | Тур | Max | Unit |
|--|--------|---------------------|-----|-----|-----|------------------|
| Operating Input Voltage | ATH | V _{IN} | 4.5 | 5.0 | 5.5 | Vdc |
| | ATS | V _{IN} | 6.0 | 12 | 14 | Vdc |
| Maximum Input Current | ATH | I _{IN,max} | | | 27 | Adc |
| (V_{IN} = $V_{IN,min}$, V_{O} = $V_{O,set}$, I_{O} = $I_{O,max}$) | ATS | I _{IN,max} | | | 26 | Adc |
| Inrush Transient | All | I ² t | | | 1 | A ² s |
| Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 1μ H source impedance; V_{IN} =6.0V to 14.0V, I_{O} = I_{Omax} ; See Figure 1) | All | | | 100 | | mAp-p |
| Input Ripple Rejection (120Hz) | All | | | 50 | | dB |

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Electrical Specifications (continued)

| Parameter | Device | Symbol | Min | Тур | Max | Unit |
|--|-------------------------------|---------------------|------|------|--------|-----------------------|
| Output Voltage Set-point | All | V _{O, set} | -1.5 | _ | +1.5 | % V _{O, set} |
| $(V_{IN}=V_{IN,min}, I_0=I_{O,max}, T_{ref}=25$ °C) | | | | | | |
| Output Voltage | All | V _{O, set} | -3.0 | | +3.0 | % V _{O, set} |
| (Over all operating input voltage, resistive load, and temperature conditions until end of life) | | | | | | |
| Adjustment Range | | | | | | |
| Selected by an external resistor | ATH | Vo | 0.8 | | 3.63 | Vdc |
| | ATS | Vo | 0.8 | | 5.5 | Vdc |
| Output Regulation | | | | | | |
| Line ($V_{IN}=V_{IN, min}$ to $V_{IN, max}$) | All | | | | 0.1 | % V _{O, set} |
| Load ($I_0=I_{0, min}$ to $I_{0, max}$) | All | | | | 0.4 | % V _{O, set} |
| Temperature ($T_{ref}=T_{A, min}$ to $T_{A, max}$) | All | | | 0.5 | 1 | % V _{O, set} |
| Output Ripple and Noise on nominal output | | | | | | |
| (V_{IN} = $V_{IN, nom}$ and I_{O} = $I_{O, min}$ to $I_{O, max}$ | | | | | | |
| $C_{OUT} = 0.01 \mu F // 0.1 \mu F // 10 \mu F$ ceramic capacitors) | | | | | | |
| Peak-to-Peak (5Hz to 20MHz bandwidth) | V ₀ ≤ 2.5V | | | | 50 | mV_{pk-pk} |
| Peak-to-Peak (5Hz to 20MHz bandwidth) | 2.5V < V ₀ ≤ 3.63V | | | | 75 | mV _{pk-pk} |
| Peak-to-Peak (5Hz to 20MHz bandwidth) | Vo > 3.63V | | | | 100 | mV _{pk-pk} |
| External Capacitance | | | | | | |
| $ESR \ge 1 \text{ m}\Omega$ | All | C _{O, max} | 0 | | 2,000 | μF |
| ESR ≥ 10 mΩ | All | C _{O, max} | 0 | | 10,000 | μF |
| Output Current (V _{IN} = 5Vdc/12Vdc) | ATH025/ATS0 25 | Io | 0 | | 25 | Adc |
| Output Current (V _{IN} = 5Vdc) | ATH030 | lo | 0 | | 30 | Adc |
| Output Current Limit Inception (Hiccup Mode) | All | lo, lim | | 120 | | % I _{omax} |
| Output Short-Circuit Current | All | I _{O, s/c} | | 20 | | % I _{omax} |
| (V ₀ ≤250mV) (Hiccup Mode) | | | | | | |
| Efficiency | $V_{O,set} = 0.8dc$ | η | | 82.0 | | % |
| V _{IN} =12Vdc, T _A =25°C | $V_{O,set} = 1.2Vdc$ | η | | 84.0 | | % |
| $I_0 = 25A$, $V_0 = V_{0,set}$ | $V_{O,set} = 1.5Vdc$ | η | | 88.0 | | % |
| | V _{O,set} = 1.8Vdc | η | | 89.5 | | % |
| | $V_{O,set} = 2.5Vdc$ | η | | 91.0 | | % |
| | $V_{O,set} = 3.3Vdc$ | η | | 92.5 | | % |
| | $V_{O,set} = 5.0Vdc$ | η | | 94.0 | | % |
| Efficiency | V _{0,set} = 0.8dc | η | | 84.0 | | % |
| V _{IN} =5Vdc, T _A =25°C | V _{O,set} = 1.2Vdc | η | | 88.5 | | % |
| Io=30A , Vo= Vo,set | V _{O,set} = 1.5Vdc | η | | 90.0 | | % |
| | V _{O,set} = 1.8Vdc | η | | 91.0 | | % |
| | V _{O,set} = 2.5Vdc | η | | 93.0 | | % |
| | $V_{O,set} = 3.3Vdc$ | η | | 95.0 | | % |
| Switching Frequency, Fixed | All | f _{sw} | _ | 300 | _ | kHz |

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Electrical Specifications (continued)

| Parameter | Device | Symbol | Min | Тур | Max | Unit |
|---|--------|----------|-----|-----|-----|------|
| Dynamic Load Response | | | | | | |
| (dI ₀ /dt=5A/ μ s; V _{IN} =V _{IN, nom} ; V ₀ =3.3V; T _A =25°C;) Load Change from Io= 0% to 50% of I ₀ ,max; No external output capacitors | | | | | | |
| Peak Deviation | ATS | V_{pk} | _ | 350 | _ | mV |
| Settling Time (Vo<10% peak deviation) | ATS | ts | _ | 20 | _ | μς |
| (dlo/dt=5A/µs; V _{IN} =V _{IN, nom} ; V _O =3.3V; T _A =25°C;) Load Change from l _O = 50% to 0%of l _{O, max} : No external output capacitors | | | | | | |
| Peak Deviation | ATS | V_{pk} | _ | 350 | _ | mV |
| Settling Time (Vo<10% peak deviation) | ATS | ts | _ | 20 | _ | μS |
| (dlo/dt=5A/µs; V _{IN} =V _{IN, nom} ; V _O =3.3V; T _A =25°C;) Load Change from Io= 0% to 50% of I _O ,max; No external output capacitors | | | | | | |
| Peak Deviation | ATH | V_{pk} | _ | 320 | _ | mV |
| Settling Time (V_0 <10% peak deviation) | ATH | ts | _ | 20 | _ | μS |
| (dI ₀ /dt=5A/ μ s; V _{IN} =V _{IN, nom} ; V ₀ =3.3V; T _A =25°C) Load Change from I ₀ = 50% to 0%of I _{0, max} : No external output capacitors | | | | | | |
| Peak Deviation | ATH | V_{pk} | _ | 250 | _ | mV |
| Settling Time (Vo<10% peak deviation) | ATH | ts | _ | 20 | _ | μS |

General Specifications

| Parameter | Min | Тур | Max | Unit |
|--|-----|-----------|-----|-------|
| Calculated MTBF (V _{IN} = V _{IN, nom} , I _O = 0.8I _{O, max} , T _A =40°C) Telecordia SR 332 Issue 1: Method 1, case 3 | | 3,016,040 | | Hours |
| Weight | _ | 7.4 | _ | g |

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Feature Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

| Parameter | Device | Symbol | Min | Тур | Max | Unit |
|--|--------|------------|------|-----|----------------------|------------------|
| On/Off Signal Interface | | | | | | |
| $(V_{IN}\!\!=\!\!V_{IN,min}$ to $V_{IN,max}$; open collector or equivalent, | | | | | | |
| Signal referenced to GND) | | | | | | |
| Logic High (Module OFF) | | | | | | |
| Input High Current | All | Іін | 0.5 | _ | 3.3 | mA |
| Input High Voltage | All | VIH | 3.0 | _ | V _{IN, max} | V |
| Logic Low (Module ON) | | | | | | |
| Input Low Current | All | lıL | _ | _ | 200 | μΑ |
| Input Low Voltage | All | VIL | -0.3 | _ | 1.2 | V |
| Turn-On Delay and Rise Times | | | | | | |
| (V _{IN} =V _{IN, nom,} I_0 =I _{0, max} , V ₀ to within ±1% of steady state) | | | | | | |
| Case 1: On/Off input is enabled and then input power is applied (delay from instant at which $V_{IN} = V_{IN}$ min until $V_0 = 10\%$ of V_0 set) | All | Tdelay | _ | 3 | | msec |
| Case 2: Input power is applied for at least one second and then the On/Off input is enabled (delay from instant at which Von/Off is enabled until $V_0 = 10\%$ of V_0 , set) | All | Tdelay | _ | 3 | | msec |
| Output voltage Rise time (time for V_0 to rise from 10% of V_0 , set to 90% of V_0 , set) | All | Trise | _ | 4 | | msec |
| Output voltage overshoot | | | | | 3.0 | $\% V_{0, set}$ |
| $I_{O} = I_{O,max};V_{IN,min} - V_{IN,max},T_{A} = 25\;{}^{\circ}C$ | | | | | | |
| Remote Sense Range | All | | _ | _ | 0.5 | V |
| Over Temperature Protection | All | T_{ref} | _ | 125 | _ | °C |
| (See Thermal Consideration section) | | | | | | |
| Sequencing Slew rate capability | All | dVsEQ/dt | | _ | 2 | V/msec |
| (V _{IN, min} to V _{IN, max} ; I _{O, min} to I _{O, max} VSEQ $<$ V _O) | | | | | | |
| Sequencing Delay time (Delay from $V_{\text{IN, min}}$ | | | | | | |
| to application of voltage on SEQ pin) | All | TSEQ-delay | 10 | | | msec |
| Tracking Accuracy Power-up (2V/ms) | All | VSEQ - | | 100 | 200 | mV |
| Power-down (1V/ms) | | VSEQ - | | 200 | 400 | mV |
| (V _{IN, min} to V _{IN, max} ; I _{O, min} - I _{O, max} VSEQ < V _{O, set}) | | | | | | |
| Input Undervoltage Lockout | | | | | | |
| Turn-on Threshold | ATH | | | 4.3 | | Vdc |
| Turn-off Threshold | ATH | | | 3.9 | | Vdc |
| Turn-on Threshold | ATS | | | 5.5 | | Vdc |
| Turn-off Threshold | ATS | | | 5.0 | | Vdc |
| Forced Load Share Accuracy | -P | | _ | 10 | | % lo |
| Number of units in Parallel | -P | | | | 5 | |

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Characteristic Curves

The following figures provide typical characteristics for the ATS025A0X (0.8V, 25A) at 25°C.

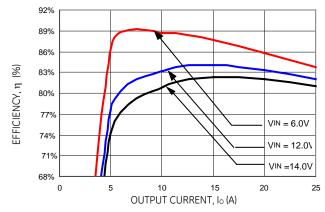


Figure 1. Converter Efficiency versus Output Current.

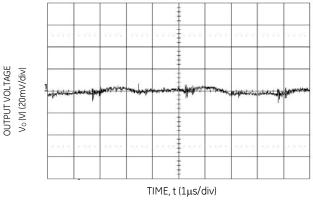


Figure 2. Typical output ripple and noise ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{O,max}$).

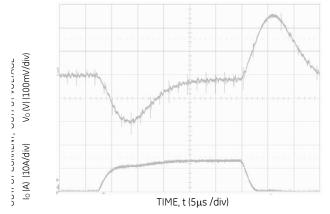


Figure 3. Transient Response to Dynamic Load Change from 0% to 50% to 0% of full load.

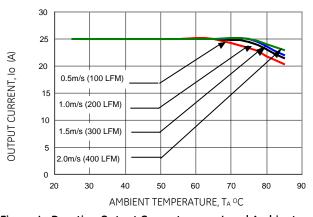


Figure 4. Derating Output Current versus Local Ambient Temperature and Airflow.

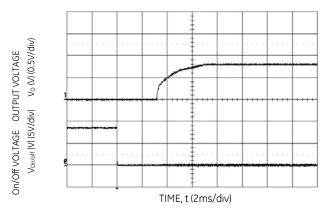


Figure 5. Typical Start-up Using Remote On/Off ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

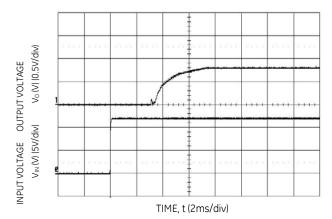


Figure 6. Typical Start-up Using Input Voltage ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Characteristic Curves

The following figures provide typical characteristics for the ATS025A0X (1.8V, 25A) at 25°C.

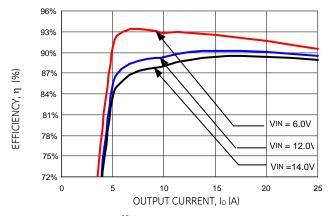


Figure 7. Converter Efficiency versus Output Current.

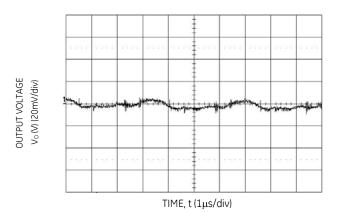


Figure 8. Typical output ripple and noise (V $_{\mbox{\scriptsize IN}}=V_{\mbox{\scriptsize IN},\mbox{\scriptsize NOM}}$, $I_{\mbox{\scriptsize O}}=I_{\mbox{\scriptsize O},\mbox{\scriptsize max}}$).

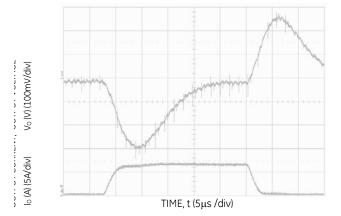


Figure 9. Transient Response to Dynamic Load Change from 0% to 50% to 0% of full load.

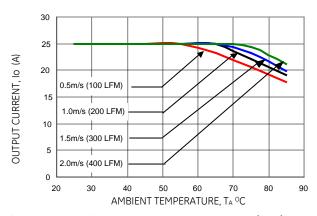


Figure 10. Derating Output Current versus Local Ambient Temperature and Airflow ((VIN = VIN,NOM).

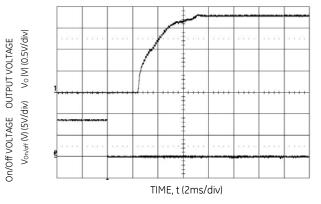


Figure 11. Typical Start-up Using Remote On/Off ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{o,max}$).

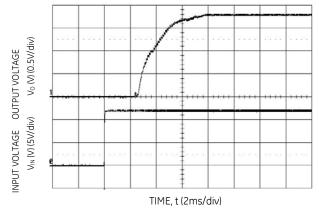


Figure 12. Typical Start-up Using Input Voltage ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

4.5Vdc - 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc - 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Characteristic Curves

The following figures provide typical characteristics for the ATS025A0X (3.3V, 25A) at 25°C.

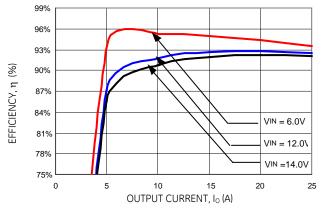


Figure 13. Converter Efficiency versus Output Current.

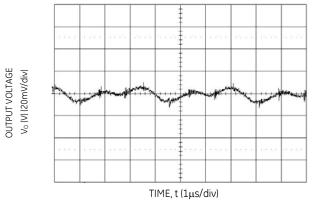


Figure 14. Typical output ripple and noise ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{O,max}$).

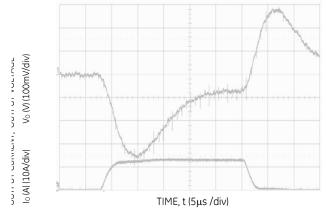


Figure 15. Transient Response to Dynamic Load Change from 0% to 50% to 0% of full load.

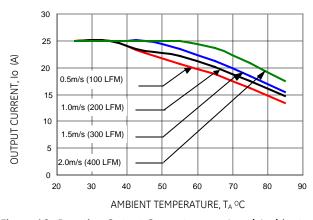


Figure 16. Derating Output Current versus Local Ambient Temperature and Airflow.

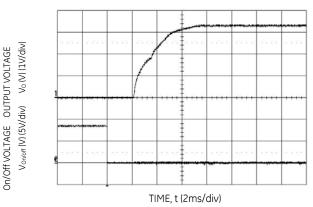


Figure 17. Typical Start-up Using Remote On/Off (VIN = VIN,NOM, Io = Io,max).

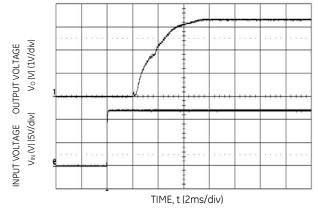


Figure 18. Typical Start-up Using Input Voltage ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Characteristic Curves

The following figures provide typical characteristics for the ATH030A0X (0.8V, 30A) at 25°C.

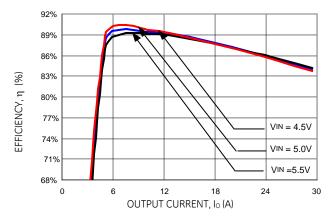


Figure 19. Converter Efficiency versus Output Current.

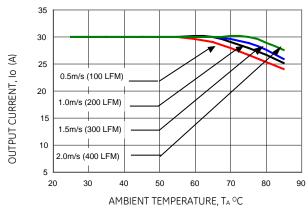


Figure 22. Derating Output Current versus Local Ambient Temperature and Airflow.

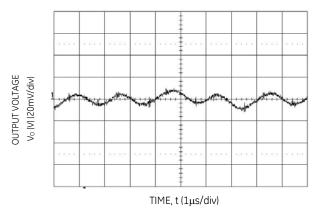


Figure 20. Typical output ripple and noise ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{O,max}$).

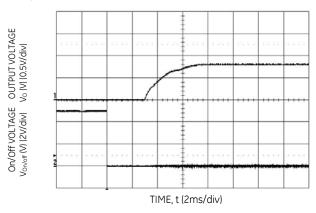


Figure 23. Typical Start-up Using Remote On/Off ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{o,max}$).

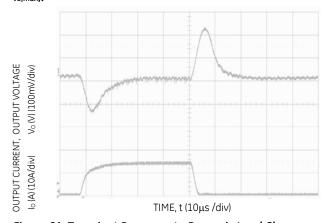


Figure 21. Transient Response to Dynamic Load Change from 0% to 50% to 0% of full load.

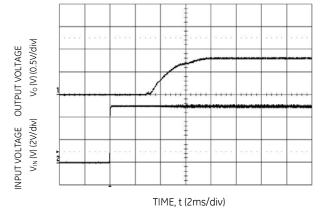


Figure 24. Typical Start-up Using Input Voltage ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Characteristic Curves

The following figures provide typical characteristics for the ATH030A0X (1.8V, 30A) at 25°C.

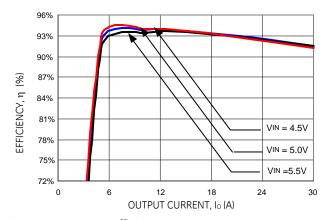


Figure 25. Converter Efficiency versus Output Current.

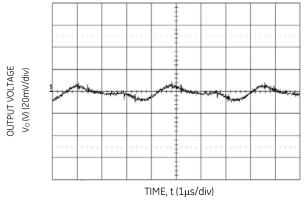


Figure 26. Typical output ripple and noise ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{O,max}$).

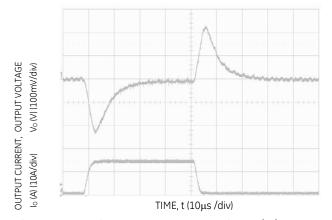


Figure 27. Transient Response to Dynamic Load Change from 0% to 50% to 0% of full load.

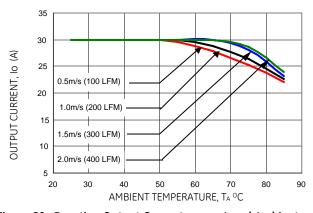


Figure 28. Derating Output Current versus Local Ambient Temperature and Airflow.

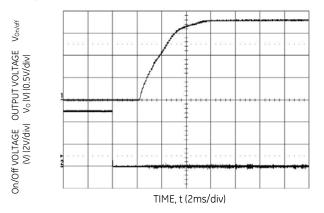


Figure 29. Typical Start-up Using Remote On/Off ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{o,max}$).

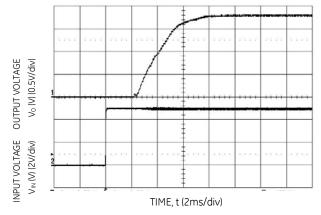


Figure 30. Typical Start-up Using Input Voltage ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Characteristic Curves

The following figures provide typical characteristics for the ATH030A0X (3.3V, 30A) at 25°C.

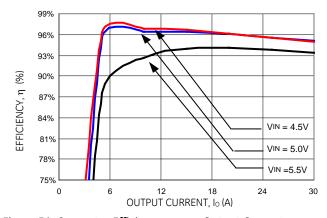


Figure 31. Converter Efficiency versus Output Current.

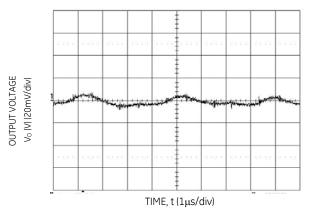


Figure 32. Typical output ripple and noise (Vin = Vin,nom, I_0 = $I_{0,max}$).

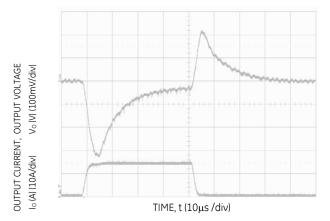


Figure 33. Transient Response to Dynamic Load Change from 0% to 50% to 0% of full load.

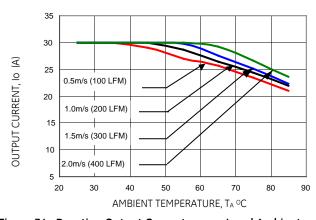


Figure 34. Derating Output Current versus Local Ambient Temperature and Airflow.

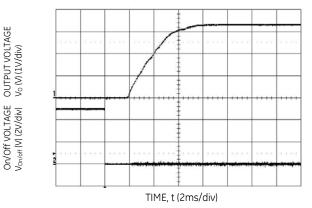


Figure 35. Typical Start-up Using Remote On/Off ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

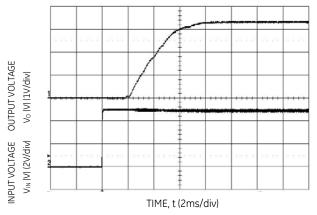
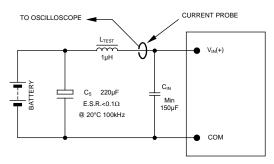


Figure 36. Typical Start-up Using Input Voltage ($V_{IN} = V_{IN,NOM}$, $I_0 = I_{0,max}$).

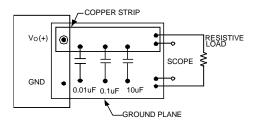
4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Test Configurations



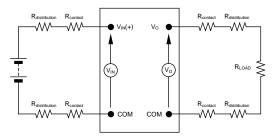
NOTE: Measure input reflected ripple current with a simulated source inductance (L_{TST}) of 1µH. Capacitor C_S offsets possible battery impedance. Measure current as shown above.

Figure 37. Input Reflected Ripple Current Test Setup.



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 38. Output Ripple and Noise Test Setup.



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 40. Output Voltage and Efficiency Test Setup.

Efficiency
$$\eta = \frac{V_0. I_0}{V_{IN}. I_{IN}} \times 100 \%$$

Design Considerations

The Austin MegaLynxTM module should be connected to a low-impedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability.

To minimize input voltage ripple, low-ESR ceramic capacitors are recommended at the input of the module. Figure 41 shows the input ripple voltage for various output voltages at 25A of load current with 2x22 μF or 4x22 μF ceramic capacitors and an input of 12V. Figure 42 shows data for the 5Vin case, with 2x47 μF and 4x47 μF of ceramic capacitors at the input, and for a load current of 30A.

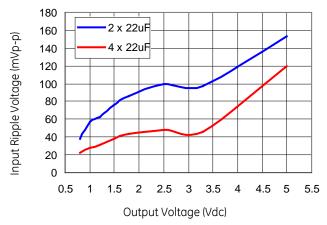


Figure 41. Input ripple voltage for various output voltages with 2x22 μ F or 4x22 μ F ceramic capacitors at the input (25A load). Input voltage is 12V.

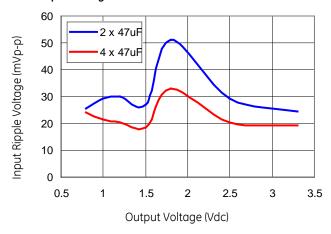


Figure 42. Input ripple voltage in mV, p-p for various output voltages with $2x47~\mu F$ or $4x47~\mu F$ ceramic capacitors at the input (25A load). Input voltage is 5V.

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Safety Considerations

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL 60950, CSA C22.2 No. 60950-00, EN60950 (VDE 0850) (IEC60950, 3rd edition) Licensed.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

Feature Descriptions

Remote On/Off

The Austin MegaLynx power modules feature a On/Off pin for remote On/Off operation. If not using the On/Off pin, connect the pin to ground (the module will be ON). The On/Off signal (Von/off) is referenced to ground. Circuit configuration for remote On/Off operation of the module using the On/Off pin is shown in Figure 43.

During a Logic High on the On/Off pin (transistor Q1 is OFF), the module remains OFF. The external resistor R1 should be chosen to maintain 3.0V minimum on the On/Off pin to ensure that the module is OFF when transistor Q1 is in the OFF state. Suitable values for R1 are 4.7K for input voltage of 12V and 3K for 5Vin. During Logic-Low when Q1 is turned ON, the module is turned ON.

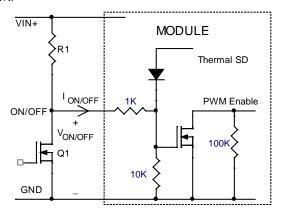


Figure 43. Remote On/Off Implementation using ON/OFF.

The On/Off pin can also be used to synchronize the output voltage start-up and shutdown of multiple modules in parallel. By connecting together the On/Off pins of multiple modules, the output start-up can be synchronized (please refer to characterization curves). When On/Off pins are connected together, all modules will shut down if any one of the modules gets disabled due to undervoltage lockout or over temperature protection.

Remote Sense

The Austin MegaLynx SIP power modules have a remote sense feature to minimize the effects of distribution losses by regulating the voltage at the remote sense pin (See Figure 44). The voltage between the Sense pin and the Vo pin must not exceed 0.5V.

The amount of power delivered by the module is defined as the output voltage multiplied by the output current (Vo \times Io). When using Remote Sense, the output voltage of the module can increase, which if the same output is maintained, increases the power output from the module. Make sure that the maximum output power of the module remains at or below the maximum rated power. When the Remote Sense feature is not being used, connect the Remote Sense pin to output of the module.

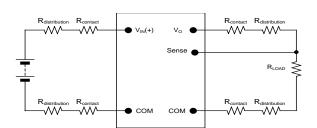


Figure 44. Effective Circuit Configuration for Remote Sense operation.

Over Current Protection

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range. The average output current during hiccup is 20% lo, max.

Over Temperature Protection

To provide protection in a fault condition, the unit is equipped with a thermal shutdown circuit. The unit will shutdown if the overtemperature threshold of 130°C is exceeded at the thermal reference point T_{ref} . The thermal shutdown is not intended as a guarantee that the unit will survive temperatures beyond its rating. Once the unit goes into thermal shutdown it will then wait to cool before attempting to restart.

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Input Under Voltage Lockout

At input voltages below the input undervoltage lockout limit, the module operation is disabled. The module will begin to operate at an input voltage above the undervoltage lockout turn-on threshold.

Output Voltage Programming

The output voltage of the Austin MegaLynx can be programmed to any voltage from 0.8dc to 5.0Vdc by connecting a resistor (shown as *Rtrim* in Figure 45) between Trim and GND pins of the module. Without an external resistor between Trim and GND pins, the output of the module will be 0.8Vdc. To calculate the value of the trim resistor, *Rtrim* for a desired output voltage, use the following equation:

$$Rtrim = \left\lceil \frac{1200}{Vo - 0.80} - 100 \right\rceil \Omega$$

Rtrim is the external resistor in Ω

Vo is the desired output voltage

By using a $\pm 0.5\%$ tolerance trim resistor with a TC of ± 100 ppm, a set point tolerance of $\pm 1.5\%$ can be achieved as specified in the electrical specification. Table 1 provides Rtrim values required for some common output voltages. The POL Programming Tool, available at www.gecriticalpower.com under the Design Tools section, helps determine the required external trim resistor needed for a specific output voltage.

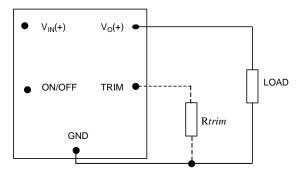


Figure 45. Circuit configuration to program output voltage using an external resistor.

Table 1

| V _{O, set} (V) | Rtrim (Ω) |
|-------------------------|-----------|
| 0.8 | Open |
| 1.0 | 5900 |
| 1.2 | 2900 |
| 1.5 | 1614 |
| 1.8 | 1100 |
| 2.5 | 606 |
| 3.3 | 380 |
| 5.0 | 186 |

Voltage Margining

Output voltage margining can be implemented in the Austin MegaLynx modules by connecting a resistor, R_{margin-up}, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, R_{margin-down}, from the Trim pin to output pin for margining-down. Figure 46 shows the circuit configuration for output voltage margining. The POL Programming Tool, available at www.gecriticalpower.com under the Design Tools section, also calculates the values of R_{margin-up} and R_{margin-down} for a specific output voltage and % margin. Please consult your local GE technical representative for additional details.

Voltage Sequencing

The Austin MegaLynx series of modules include a sequencing feature that enables users to implement various types of output voltage sequencing in their applications. This is accomplished via an additional sequencing pin. When not using the sequencing feature, either leave the SEQ pin unconnected or tied to V_{IN}.

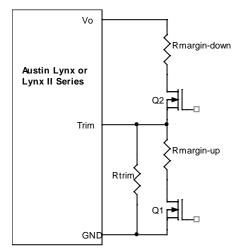


Figure 46. Circuit Configuration for margining Output voltage.

For proper voltage sequencing, first, input voltage is applied to the module. The On/Off pin of the module is left unconnected or tied to GND for negative logic modules so that the module is ON by default. After applying input voltage to the module, a

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

delay of 10msec minimum is required before applying voltage on the SEQ pin. During this delay time, the SEQ pin should be kept at a voltage of 50mV (\pm 20 mV). After the 10msec delay, the voltage applied to the SEQ pin is allowed to vary and the output voltage of the module will track this voltage on a one-to-one volt basis until the output reaches the set-point voltage. To initiate simultaneous shutdown of the modules, the sequence pin voltage is lowered in a controlled manner. The output voltages of the modules track the sequence pin voltage when it falls below their set-point voltages. A valid input voltage must be maintained until the tracking and output voltages reach zero to ensure a controlled shutdown of the modules. For a more detailed description of sequencing, please refer to Application Note AN04-008 titled "Guidelines for Sequencing of Multiple Modules".

When using the EZ-SEQUENCETM feature to control start-up of the module, pre-bias immunity feature during start-up is disabled. The pre-bias immunity feature of the module relies on the module being in the diode-mode during start-up. When using the EZ-SEQUENCETM feature, modules goes through an internal set-up time of 10msec, and will be in synchronous rectification mode when voltage at the SEQ pin is applied. This will result in sinking current in the module if pre-bias voltage is present at the output of the module. When pre-bias immunity during start-up is required, the EZ-SEQUENCETM feature must be disabled.

Active Load Sharing (-P Option)

For additional power requirements, the Austin MegaLynx series power module is also available with a parallel option. Up to five modules can be configured, in parallel, with active load sharing. Good layout techniques should be observed when using multiple units in parallel. To implement forced load sharing, the following connections should be made:

- The share pins of all units in parallel must be connected together. The path of these connections should be as direct as possible.
- All remote-sense pins should be connected to the power bus at the same point, i.e., connect all the SENSE(+) pins to the (+) side of the bus. Close proximity and directness are necessary for good noise immunity

Some special considerations apply for design of converters in parallel operation:

• When sizing the number of modules required for parallel operation, take note of the fact that current sharing has some tolerance. In addition, under transient condtions such as a dynamic load change and during startup, all converter output currents will not be equal. To allow for such variation and avoid the likelihood of a converter shutting off due to a current overload, the total capacity of the paralleled system should be no more than 75% of the sum of the individual converters. As an example, for a system of four ATS030A0X3-SR converters the parallel, the total current drawn should be less that 75% of (4 x 30A), i.e. less than 90A.

- All modules should be turned on and off together. This is so that all modules come up at the same time avoiding the problem of one converter sourcing current into the other leading to an overcurrent trip condition. To ensure that all modules come up simultaneously, the on/off pins of all paralleled converters should be tied together and the converters enabled and disabled using the on/off pin.
- The share bus is not designed for redundant operation and the system will be non-functional upon failure of one of the unit when multiple units are in parallel. In particular, if one of the converters shuts down during operation, the other converters may also shut down due to their outputs hitting current limit. In such a situation, unless a coordinated restart is ensured, the system may never properly restart since different converters will try to restart at different times causing an overload condition and subsequent shutdown. This situation can be avoided by having an external output voltage monitor circuit that detects a shutdown condition and forces all converters to shut down and restart together.

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Thermal Considerations

Power modules operate in a variety of thermal environments; however, sufficient cooling should always be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel. The test set-up is shown in Figure 47. Note that the airflow is parallel to the long axis of the module as shown in Figure 48. The derating data applies to airflow in either direction of the module's long axis.

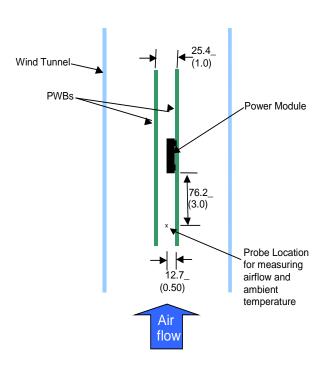


Figure 47. Thermal Test Set-up.

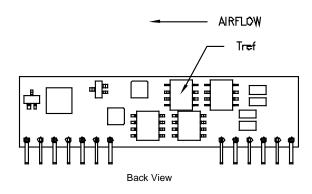


Figure 48. Tref Temperature measurement location.

The thermal reference point, T_{ref} used in the specifications is shown in Figure 48. For reliable operation this temperature should not exceed 125°C.

The output power of the module should not exceed the rated power of the module (Vo,set x Io,max).

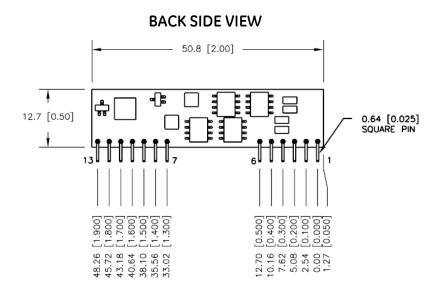
Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Mechanical Outline of Module

Dimensions are in millimeters and (inches).

Tolerances: x.x mm \pm 0.5 mm (x.xx in. \pm 0.02 in.) [unless otherwise indicated] x.xx mm \pm 0.25 mm (x.xxx in \pm 0.010 in)



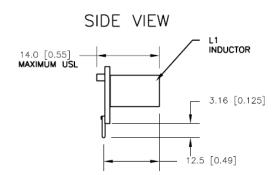
Pin out

| Pin | Function | | | | |
|-----|----------|--|--|--|--|
| 1 | Vo | | | | |
| 2 | Vo | | | | |
| 3 | Sense+ | | | | |
| 4 | Vo | | | | |
| 5 | GND | | | | |
| 6 | GND* | | | | |
| 7 | Share** | | | | |
| 8 | GND | | | | |
| 9 | VIN | | | | |
| 10 | VIN | | | | |
| 11 | SEQ | | | | |
| 12 | Trim | | | | |
| 13 | On/Off | | | | |

Pin 6 is added in

ATH030A0X3 version

** Pin 7 is paralleling option

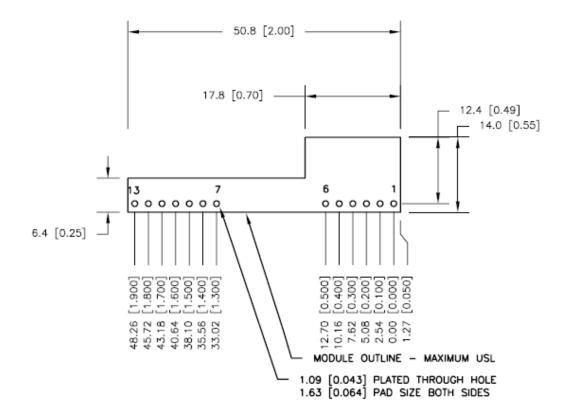


4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Recommended Pad Layout

Dimensions are in millimeters and (inches).

Tolerances: x.x mm \pm 0.5 mm (x.xx in. \pm 0.02 in.) [unless otherwise indicated] x.xx mm \pm 0.25 mm (x.xxx in \pm 0.010 in)



4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Through-Hole Lead-Free Soldering Information

The RoHS-compliant through-hole products use the SAC (Sn/Ag/Cu) Pb-free solder and RoHS-compliant components. They are designed to be processed through single or dual wave soldering machines. The pins have an RoHS-compliant finish that is compatible with both Pb and Pb-free wave soldering processes. A maximum preheat rate of 3°C/s is suggested. The wave preheat process should be such that the temperature of the power module board is kept below 210°C. For Pb solder, the recommended pot temperature is 260°C, while the Pb-free solder pot is 270°C max. Not all RoHS-compliant through-hole products can be processed with paste-through-hole Pb or Pb-free reflow process. If additional information is needed, please consult with your GE technical representative for more details.

4.5Vdc – 5.5Vdc input; 0.8Vdc to 3.63Vdc output; 30A Output Current 6Vdc – 14Vdc input; 0.8Vdc to 3.63Vdc output; 25A Output Current

Ordering Information

Please contact your GE Sales Representative for pricing, availability and optional features.

Table 2. Device Codes

| Input Voltage | Output Voltage | Output Current | On/Off Logic | Connector Type | Product codes | Comcodes |
|---------------|----------------|-------------------|-----------------|-------------------|-----------------|-------------|
| 4.5 – 5.5Vdc | 0.8 - 3.63Vdc | 25A | Negative | SIP | ATH025A0X3 | 108991980 |
| 4.5 – 5.5Vdc | 0.8 - 3.63Vdc | 25A | Negative | SIP | ATH025A0X3Z | CC109104774 |
| 4.5 – 5.5Vdc | 0.8 – 3.63Vdc | 30A | Negative | SIP | ATH030A0X3 | 108992005 |
| 4.5 – 5.5Vdc | 0.8 – 3.63Vdc | 30A | Negative | SIP | ATH030A0X3Z | CC109104782 |
| 4.5 – 5.5Vdc | 0.8 – 3.63Vdc | 30A | Negative | SIP | ATH030A0X3-P | 108993358 |
| 4.5 – 5.5Vdc | 0.8 – 3.63Vdc | 30A | Negative | SIP | ATH030A0X3-PZ | CC109104790 |
| 6.0 – 14Vdc | 0.8- 5.5Vdc | 25A | Negative | SIP | ATS025A0X3 | 108991997 |
| 6.0 – 14Vdc | 0.8- 5.5Vdc | 25A | Negative | SIP | ATS025A0X3Z | CC109104808 |
| 6.0 – 14Vdc | 0.8- 5.5Vdc | 25A | Negative | SIP | ATS025A0X53 | 108997210 |
| 6.0 – 14Vdc | 0.8- 5.5Vdc | 25A | Negative | SIP | ATS025A0X3-P | 108993341 |
| 6.0 – 14Vdc | 0.8- 5.5Vdc | 25A | Negative | SIP | ATS025A0X3-PZ | CC109104816 |
| 6.0 – 14Vdc | 0.8- 5.5Vdc | 25A | Negative | SIP | ATS025A0X53-PZ | CC109107752 |
| 6.0 – 14Vdc | 0.8- 5.5Vdc | 25A | Negative | SIP | ATS025A0X3-34Z* | CC109147897 |

^{*} Special part, consult factory before ordering

imagination at work

Table 3. Device Options

| Option | Device Code Suffix |
|--|--------------------|
| Long pins 5.08 mm ± 0.25 m (0.2 in. ± 0.010 in.) | -5 |
| Paralleling with active current sharing | -P |
| RoHS Compliant | -Z |

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